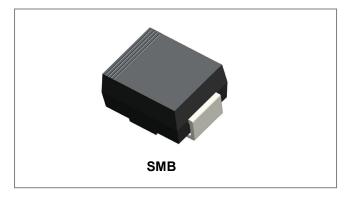


SD560BP

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SD560BP STANDARD RECTIFIER



Features

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop
- Low Power Loss
- Built Strain Relief
- Plastic Case Material has UL Flammability Classification Rating 94V-O
- This is a Halogen Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Data

- Case: SMB molded plastic body
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.09 grams

Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Characteristic	Symbol	SD560BP	Units
Maximum Peak Repetitive Reverse Voltage Maximum DC Blocking Voltage	V _{RRM} V _{DC}	600	V
Maximum RMS Voltage	V _{RMS}	420	V
Maximum Average Forward Rectified Current in DC $@T_c = 75^{\circ}C$	I _(AV)	5.0	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	200	A
I ² t Rating for fusing (t < 8.3ms)	l ² t	166	A ² S
Maximum Instantaneous Forward Voltage* @I _F = 5.0A	VF	1.2	V
Maximum DC Reverse Current*@T _A = 25°CAt Rated DC Blocking Voltage*@T _A = 100°C	I _R	9.0 170	uA
Typical Junction Capacitance (Note 1)	Cj	32	pF
Typical Thermal Resistance Junction to Case (Note 2)	$R_{ ext{ heta}JC}$	7.1	°C/W
Typical Thermal Resistance Junction to Lead (Note 2)	Rejl	3.7	°C/W
Typical Thermal Resistance Junction to Ambient (Note 2)	R _{0JA}	43	°C/W
Operating Storage Temperature Range	Tstg	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +175	°C

* Pulse width < 300 μ s, duty cycle < 2%

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

2. Thermal resistance tested without heat sink.

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Circuit Diagram



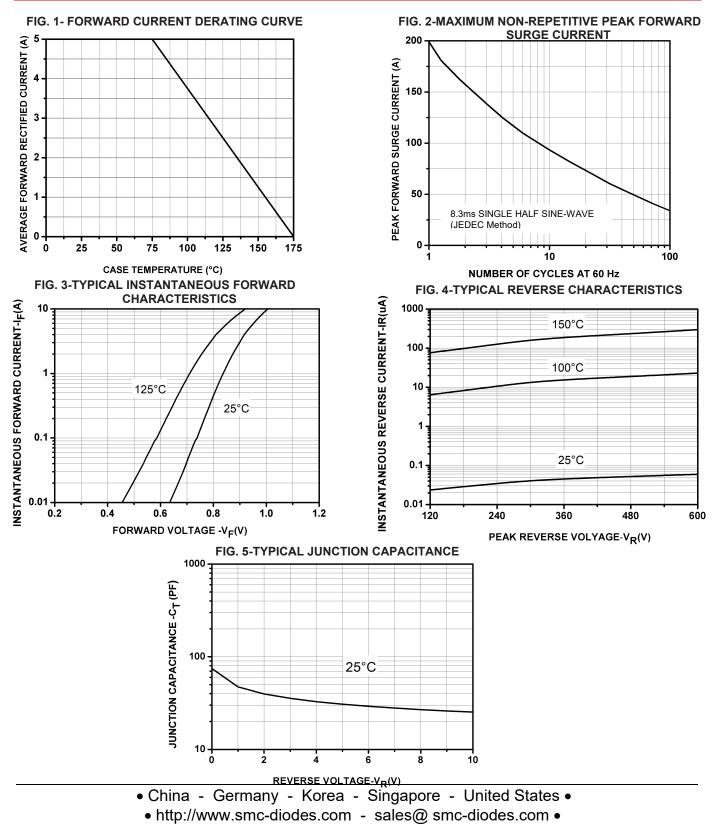


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Ratings and Characteristics Curves



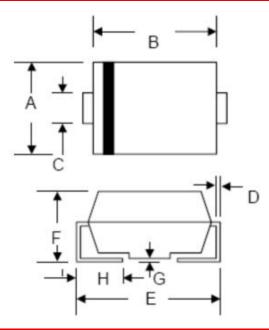


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Mechanical Dimensions SMB



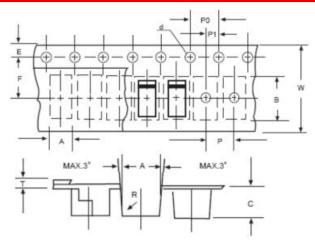
Millimeters		Inches		
STIVIDUL	Min.	Max.	Min.	Max.
A	3.30	3.94	0.130	0.155
В	4.06	4.70	0.160	0.185
С	1.80	2.20	0.071	0.087
D	0.152	0.305	0.006	0.012
E	4.80	5.59	0.189	0.220
F	2.10	2.60	0.083	0.102
G	0.051	0.203	0.002	0.008
Н	0.76	1.52	0.030	0.060

Ordering Information

Device	Package	Shipping
SD560BP	SMB(Pb-Free)	3000pcs / reel
SD560BPTR	SMB(Pb-Free)	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Carrier Tape Specification SMB



	SD560BP	
_	XXXXX	

Marking Diagram

Where XXXXX is YYWWL

SD560BP = Part Name YY = Year WW = Week L = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

SYMBOL	Millimeters		
STWBUL	Min.	Max.	
A	3.99	4.19	
В	5.72	5.92	
С	3.23	3.43	
d	1.40	1.60	
E	1.40	1.60	
F	5.60	5.70	
Р	7.90	8.10	
P0	3.90	4.10	
P1	1.90	2.10	
Т	-	0.60	
W	11.80	12.20	

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